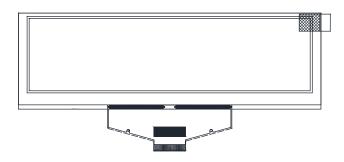


Vishay

256 x 64 Graphic OLED



MECHANICAL DATA					
ITEM	STANDARD VALUE	UNIT			
Module dimension	146.0 x 45.0 x 2.05				
Viewing area	137.65 x 35.89				
Active area	135.65 x 33.89				
Dot size	0.50 x 0.50	mm			
Dot pitch	0.53 x 0.53				
Mounting hole	n/a				

FEATURES

- Type: graphic
- Display format: 256 x 64 dots
- Built-in controller: SSD1322
- Duty cycle: 1/64
- +3 V power supply
- Interface: I²C, 4-wire SPI, 6800, 8080
- Without polarizer
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

ABSOLUTE MAXIMUM RATINGS						
ITEM	SYMBOL	STANDAF	UNIT			
	STWIDOL	MIN.	MAX.	UNIT		
Supply voltage for operation ⁽¹⁾⁽²⁾	V _{CI}	-0.3	4	V		
Supply voltage for logic ⁽¹⁾⁽²⁾	V _{DD}	-0.5	2.75	V		
Supply voltage for I/O pins ⁽¹⁾⁽²⁾	V _{DDI/O}	-0.5	V _{CI}	V		
Supply voltage for display ⁽¹⁾⁽²⁾	V _{CC}	-0.5	20	V		
Operating temperature	T _{OP}	-40	+80	°℃		
Storage temperature	T _{STG}	-40	+80	0		

Notes

- $^{(1)}\,$ All the above voltages are on the basis of "V_{SS} = 0 V"
- (2) When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate

ELECTRICAL CHARACTERISTICS									
ITEM	SYMPOL CONDITION STANDARD VALUE			SYMBOL CONDITION STANDARD VALU	SYMBOL CONDITION STANDARD VAL	STANDARD VA		.UE	UNIT
	STIVIDOL	CONDITION	MIN.	TYP.	MAX.	UNIT			
Supply voltage for logic	V _{CI}	(1)	2.8	3.0	3.3				
Supply voltage for display	V _{CC}	-	14	14.5	16				
High level input	V _{IH}	-	0.8 V _{DD}	-	V _{DDI/O}	v			
Low level input	VIL	-	0	-	0.2 V _{DDI/O}	v			
High level output	V _{OH}	-	0.9 V _{DDI/O}	-	V _{DDI/O}				
Low level output	V _{OL}	-	0	-	0.1 V _{DDI/O}				
50 % check board operating current	I _{DD}	V _{CC} = 14.5 V	34	36	45	mA			

Note

• Supply voltage for logic = V_{DD} core power supply can be regulated from V_{CI}

EMITTING COLOR	
YELLOW GREEN RED BLUE WHI	TE
Yes	

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Pb-free

RoHS COMPLIANT



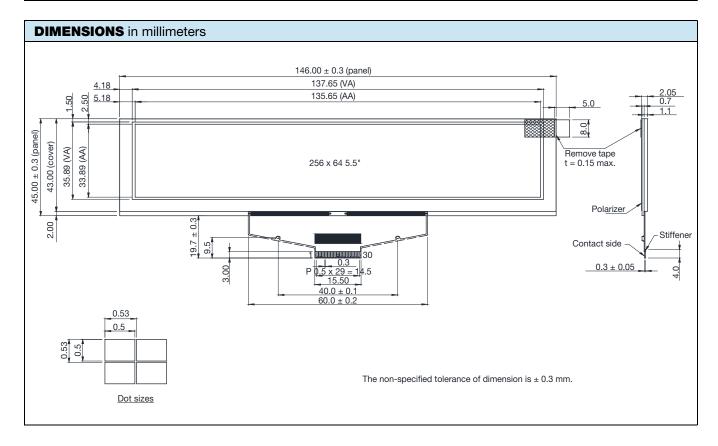
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INTERF	ACE PIN F	UNCTI	ON					
PIN NO.	SYMBOL	I/O			FUNCTION			
POWER S	JPPLY							
26	V _{CI}	Р	This	Power supply for operation This is a voltage supply pin. It must be connected to external source and always be equal to or higher than V_{DD} and $V_{DDI/O}$				
25	V _{DD}	Р	This regu	Power supply for core logic circuit This is a voltage supply pin. It can be supplied externally (within the range of 2.4 V to 2.6 V) or regulated internally from V_{CI} . A capacitor should be connected between this pin and V_{SS} under all circumstances				
24	V _{DDI/O}	Р	This sign	Power supply for I/O pin This pin is a power supply pin of I/O buffer. It should be connected to V_{DD} or external source. All I/O signal should have V_{IH} reference to $V_{DDI/O}$. When I/O signal pins (BS0 to BS1, D0 to D7, control signals) pull "high", they should be connected to $V_{DDI/O}$				
2	V _{SS}	Р			s a reference for the logic pi	ns. It must be connected to exte	rnal	
3, 29	V _{CC}	Р		•	ge supply pin of the chip. T	They must be connected to exte	rnal	
5, 28	V _{LSS}	Р		Ground of analog circuit These are the analog ground pins. They should be connected to V _{SS} externally				
DRIVER								
22	I _{REF}	I	This	Current reference for brightness adjustment This pin is segment current reference pin. A resistor should be connected between this pin and V_{SS} . Set the current lower than 10 μ A				
4	V _{COMH}	Р	This	Voltage output high level for COM signal This pin is the input pin for the voltage output high level for COM signals. A tantalum capacitor should be connected between this pin and V_{SS}				
27	V _{SL}	Р	Voltage output low level for SEG signal This is segment voltage reference pin. When external V_{SL} is not used, this pin should be left open. When external V_{SL} is used, this pin should connect with resistor and diode to ground					
TESTING F	PADS			· ·				
21	FR	0		pin is no connection pins. Not idually	hing should be connected to	this pin. This pin should be left o	pen	
16	DOO			municating protocol select e pins are MCU interface sele	ction input. See the following	g table:		
	BS0				BS0	BS1		
		I		3-wire SPI	1	0		
				4-wire SPI	0	0		
17	BS1			8-bit 68XX parallel	1	1		
				8-bit 80XX parallel	0	1		
20	RES#	I	-	er reset for controller and driv pin is reset signal input. Wher		of the chip is executed		
19	CS#	I	This	Chip select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled "low"				
18	D / C#	I	This as d regis	Data / command control This pin is data / command control pin. When the pin is pulled "high", the input at D7 to D0 is treated as display data. When the pin is pulled "low", the input at D7 to D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the timing characteristics diagrams				
14	E / RD#	I	This usec CS# sign	as the enable (E) signal. Read is pulled "low". When connect	d / write operation is initiated ting to an 80XX-microproces ated when this pin is pulled '	eries microprocessor, this pin wil d when this pin is pulled high and ssor, this pin receives the read (R 'low" and CS# is pulled "low". W	the RD#)	



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INTERF	INTERFACE PIN FUNCTION				
PIN NO. SYMBOL I/O			FUNCTION		
15	R / W#	I	Read / write select or write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as read / write (R/W#) selection input. Pull this pin to "high" for read mode and pull it to "low" for write mode. When 80XX interface mode is selected, this pin will be the write (WR#) input. Data write operation is initiated when this pin is pulled "low" and the CS# is pulled "low". When serial mode is selected, this pin must be connected to V _{SS}		
6 to 13	to 13 D/ to DU I/O serial mode is selected, D1 will be the serial data input SDIN and D0 wi		Host data input / output bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. Unused pins must be connected to V _{SS} except for D2 in serial mode		
RESERVE					
23	NC	-	Reserved pin The NC pin between function pins are reserved for compatible and flexible design		
1, 30	NC (GND)	-	Reserved pin (supporting pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground		



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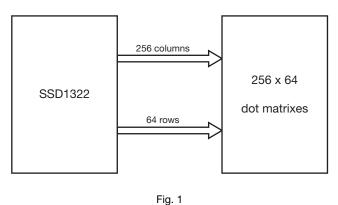
MODULE CLA	SSIFICATION INFORM	ATION
OLED - [1	256 Y 064 D 1 1 1 2 3 4 5	
1	Brand	Vishay Intertechnology, Inc.
2	Horizontal format	256 columns
3	Display type	F: COG type, with frame H: graphic type N: character type O: COG type Y: tab type
4	Vertical format	64 lines
5	Serials code	D
6	Emitting color	A: amber B: blue C: full color G: green L: yellow R: red S: sky blue W: white X: yellow / sky blue (dual color) Y: yellow green
7	Polarizer	N: without polarizer P: with polarizer
8	Display mode	A: active matrix P: passive matrix
9	Driver voltage	3: 3.0 V to 3.3 V 5: 5.0 V
10	Touch panel	N: without touch panel T: with touch panel
11	Products type	0: standard 1: sunlight readable 2: transparent OLED (TOLED) 3: flexible OLED 4: OLED for lighting
12	Product grades	0: standard (A level) 2: B level 3: C level 4: high class (AA level) 5: customer offerings
13	Serial number	Application serial number (000 to ZZZ)

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GENERAL SPECIFICATIONS					
ITEM	DIMENSION	UNIT			
Dot matrix	256 x 64				
Module dimension	146.0 x 45.0 x 2.05	mm			
Viewing area	137.65 x 35.89	mm			
Active area	135.65 x 33.89	mm			
Dot size	0.50 x 0.50	mm			
Dot pitch	0.53 x 0.53	mm			
Display mode	Passive matrix				
Display color	Yellow				
Drive duty	1/64				
IC	SSD1322				

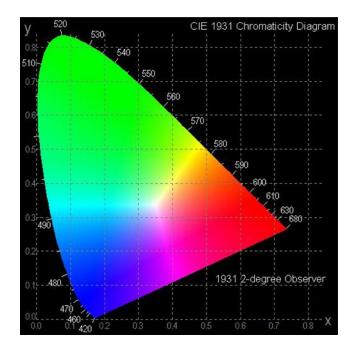
FUNCTION BLOCK DIAGRAM



For more information, please refer to Application Note provided • by Vishay

OPTICAL CHARACTERISTICS						
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
View engle	(V) 0		160	-	-	dog
View angle	(H)φ		160	-	-	deg
Contrast ratio	CR	Dark	2000 : 1	-	-	-
Despense time	t _{rise}		-	10	-	μs
Response time	t _{fall}		-	10	-	μs
Display with 50 % check board brightness			40	60	-	cd/m ²
CIE _x (yellow)	(CIE1931)		0.45	0.47	0.49	
CIE _y (yellow)	(CIE1931)		0.48	0.50	0.52	

Note



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LED	ЕСТ	C

ITEM	CONDITIONS	MIN.	TYP.
Operating life time	$T_A = 25$ °C, initial 50 % check board brightness typical value	50 000 h	-

Notes

• Life time is defined the amount of time when the luminance has decayed to < 50 % of the initial value

• This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (PDF) for the product under normal use conditions

Screen saving mode will extend OLED lifetime

RELABILITY		
ENVIRONMENTAL TEST		
TEST ITEM	CONTENT OF TEST	TEST CONDITION
High temperature storage	Endurance test applying the high storage temperature for a long time	80 °C, 240 h
Low temperature storage	Endurance test applying the low storage temperature for a long time	-40 °C, 240 h
High temperature operation	Endurance test applying the electric stress (voltage and current) and the thermal stress to the element for a long time	80 °C, 240 h
Low temperature operation	Endurance test applying the electric stress under low -40 °C, 240 h	
High temperature / humidity storage	Endurance test applying the high temperature and high humidity storage for a long time 60 °C, 90 % RH	
Temperature cycle	Endurance test applying the low and high temperature cycle -40 °C 25 °C 80 °C	-40 °C / 80 °C, 100 cycles
	30 min 5 min 30 min 1 cycle	
MECHANICAL TEST		
Vibration test	Endurance test applying the vibration during transportation and using	10 Hz to 22 Hz for 1.5 mm peak-to-peak, 22 Hz to 500 Hz for 1.5 <i>g</i> , total 0.5 h
Shock test	Constructional and mechanical endurance test applying the shock during transportation	50 g half sin wave 11 ms, 3 times of each direction
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air	115 mbar, 40 h
OTHERS		
Static electricity test	Endurance test applying the electric stress to the terminal	V_{S} = \pm 600 V (contact), \pm 800 V (air), R_{S} = 330 $\Omega,$ C_{S} = 150 pF, 10 times

Note

Supply voltage for OLED system = operating voltage at 25 °C

TEST AND MEASUREMENT CONDITIONS

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hours prior to conducting the failure test at 23 °C ± 5 °C, 55 % ± 15 % RH
- 2. All-pixels-on is used as operation test pattern
- 3. The degradation of polarizer are ignored for high temperature storage, high temperature / humidity storage, temperature cycle

EVALUATION CRITERIA

- 4. The function test is OK
- 5. No observable defects
- 6. Luminance: > 50 % of initial value
- 7. Current consumption: within ± 50 % of initial value

APPENDIX: RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

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INS	PECTION SPECIE	FICATION				
NO.	ITEM		CRITERIO	N		AQL
01	Electrical testing	 1.1 Missing vertical, horizontal segment, segment contrast defect 1.2 Missing character, dot or icon 1.3 Display malfunction 1.4 No function or no display 1.5 Current consumption exceeds product specifications 1.6 OLED viewing angle defect 1.7 Mixed product types 1.8 Contrast defect 		0.65		
02	spots on OLED (display only)	2.1 White and black spots on display ≤ 0.25 mm, no more than three white or black spots present 2 2.2 Densely spaced: no more than two spots or lines within 3 mm 2			2.5	
03	OLED black spots, white spots, contamination (non-display)	3.1 Round type: as following $\Phi = (x + y) / 2$ $\Rightarrow x = \frac{1}{y}$	drawing	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	ACCEPTABLE QTY Accept no dense 2 1 0	2.5
		3.2 Line type (as following drawing) → L ↓ W	LENGTH - $L \le 3.0$ $L \le 2.5$ -	WIDTH $W \le 0.02$ $0.02 < W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W$	ACCEPTABLE QTY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are visible, judge specifications, not easy to fi specify direction.	using black spot nd, must check in		ACCEPTABLE QTY Accept no dense 3 2 0 3	2.5
05	Scratches	Follow no. 3 OLED black spots,	white spots, contami	nation		
06	Chipped glass	Symbols: x: chip length k: seal width l: electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface ar k z: chip thickness $z \le 1/2$ t $1/2$ t < $z \le 2$ t Note If there are 2 or more chips,	y: chip width t: glass thickness nd crack between pane y y z y: chip width Not over viewing a Not exceed 1/3 k	els: $x \rightarrow y \rightarrow z$ area	z: chip thickness a: OLED side length v v x x x chip length $x \le 1/8$ a $x \le 1/8$ a	2.5

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NO.	ITEM		CRITERION		AQ
10.		6.1.2 Corner crack:	ONTENION		
6	Chipped glass	z: chip thickness $z \le 1/2$ t	y: chip width Not over viewing area	x: chip length x ≤ 1/8 a	2.5
		$1/2 t < z \le 2 t$	Not exceed 1/3 k	x ≤ 1/8 a	
		Note		x 3 1/0 a	
			, x is total length of each chip		
		Symbols: x: chip length k: seal width l: electrode pad length 6.2 Protrusion over termin 6.2.1 Chip on electrode pad		z: chip thickness a: OLED side length	
		y: chip width y ≤ 0.5 mm 6.2.2 Non-conductive portic	x: chip length x \le 1/8 a	z: chip thickness $0 < z \le t$	
6	Glass crack	y y z			2.
		y: chip width	x: chip length	z: chip thickness	
		y ≤ I	x ≤ 1/8 a	0 < z ≤ t	1
		according to electrode tern	ealed by the customer, the alignment		
					1

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INSPECTION SPECIFICATION				
NO.	ITEM	CRITERION	AQL	
		8.1 Illumination source flickers when lit	0.65	
08	Backlight elements	8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards	2.5	
		8.3 Backlight does not light or color wrong	0.65	
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination	2.5	
09	Dezei	9.2 Bezel must comply with job specifications	0.65	
		10.1 COB seal may not have pinholes larger than 0.2 mm or contamination	2.5	
		10.2 COB seal surface may not have pinholes through to the IC	2.5	
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram	0.65	
		10.4 There may not be more than 2 mm of sealant outside the seal area on the PCB. And there should be no more than three places	2.5	
10	PCB, COB	10.5 No oxidation or contamination PCB terminals	2.5	
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts	0.65	
		10.7 The jumper on the PCB should conform to the product characteristic chart	0.65	
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down	2.5	
	Soldering	11.1 No un-melted solder paste may be present on the PCB	2.5	
11		11.2 No cold solder joints, missing solder connections, oxidation or icicle	2.5	
11		11.3 No residue or solder balls on PCB	2.5	
		11.4 No short circuits in components on PCB	0.65	
		12.1 No oxidation, contamination, curves or, bends on interface pin (OLB) of TCP	2.5	
		12.2 No cracks on interface pin (OLB) of TCP	0.65	
12		12.3 No contamination, solder residue or solder balls on product	2.5	
	General appearance	12.4 The IC on the TCP may not be damaged, circuits	2.5	
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever	2.5	
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color	2.5	
		12.7 Sealant on top of the ITO circuit has not hardened	2.5	
		12.8 Pin type must match type in specification sheet	0.65	
		12.9 OLED pin loose or missing pins	0.65	
		12.10 Product packaging must the same as specified on packaging specification sheet	0.65	
		12.11 Product dimension and structure must conform to product specification sheet	0.65	



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OLED-256Y064D-LPP3N00000

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CHECK ITEM	CLASSIFICATION	CRITERIA
No display	Major	
Missing line	Major	
	iviajoi	
Pixel short	Major	
Darker short	Major	
Wrong display	Major	
Un-uniform	Maian	
B/A x 100 % < 70 % A/C x 100 % < 70 %	Major	A Normal B Dark pixel C Light pixel

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PRECAUTIONS IN USE OF OLED MODULES

MODULES

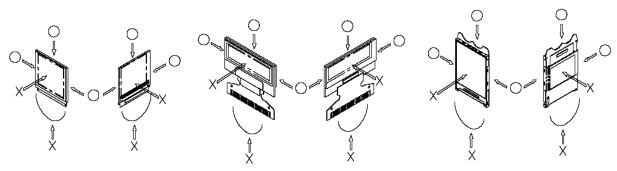
- 1. Avoid applying excessive shocks to module or making any alterations or modifications to it
- 2. Do not make extra holes on the printed circuit board, modify its shape or change the components of OLED display module
- 3. Do not disassemble the OLED display module
- 4. Do not operate it above the absolute maximum rating
- 5. Do not drop, bend or twist OLED display module
- 6. Soldering: only to the I/O terminals
- 7. Storage: please storage in anti-static electricity container and clean environment
- 8. It is pretty common to use "screen saver" to extend the lifetime and do not use fix information for long time in real application
- 9. Do not use fixed information in OLED panel for long time, that will extend "screen burn" effect time
- 10. Vishay has the right to change the passive components, including R2 and R3 adjust resistors. (Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier)
- 11. Vishay have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization, and the best product performance... etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay have the right to modify the version)

HANDLING PRECAUTIONS

- 1. Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position
- 2. If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance
- 3. If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections
- 4. The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module
- 5. When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape
- Scotch mending tape no. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the polarizer:

- Water
- Ketone
- Aromatic solvents
- 6. Hold OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases



- 7. Do not apply stress to the LSI chips and the surrounding molded sections
- 8. Do not disassemble nor modify the OLED display module
- 9. Do not apply input signals while the logic power is off

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- 10. Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity
 - Be sure to make human body grounding when handling OLED display modules
 - Be sure to ground tools to use or assembly such as soldering irons
 - To suppress generation of static electricity, avoid carrying out assembly work under dry environments
 - Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film
- 11. Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above no. 5
- 12. If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above

STORAGE PRECAUTIONS

- 1. When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps and, also, avoiding high temperature and high humidity environment or low temperature (less than 0 °C) environments. We recommend you to store these modules in the packaged state when they were shipped from Vishay. At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them
- 2. If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above

DESIGNING PRECAUTIONS

- 1. The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen
- 2. To prevent occurrence of malfunctioning by noise, pay attention to satisfy the V_{IL} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible
- 3. We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (V_{DD}) (recommend value: 0.5 A)
- 4. Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices
- 5. As for EMI, take necessary measures on the equipment side basically
- 6. When fastening the OLED display module, fasten the external plastic housing section
- 7. If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module
 - Connection (contact) to any other potential than the above may lead to rupture of the IC

PRECAUTIONS WHEN DISPOSING OF THE OLED DISPLAY MODULES

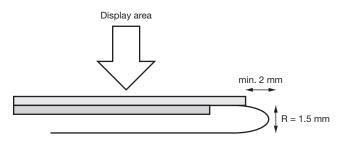
1. Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations

OTHER PRECAUTIONS

- 1. When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module
- 2. To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules
 - Pins and electrodes
 - Pattern layouts such as the TCP and FPC
- 3. With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur
 - Design the product and installation method so that the OLED driver may be shielded from light in actual usage
 - Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes



- 4. Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design
- 5. We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise
- 6. Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier
- 7. Our company will has the right to upgrade and modify the product function
- 8. The limitation of FPC bending





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